

Application Note: JN-AN-1250

Memsize Tool

1 Application Note Overview

The purpose of this Application Note is to show how to use the memory profiling tool, memsize, and apply it to another Application Note.

The memsize tool is a simple memory profiling tool that creates an ExcelWorkbook (.xlsx) with three sheets:

• Sections – all sections, their addresses, sizes, and regions.

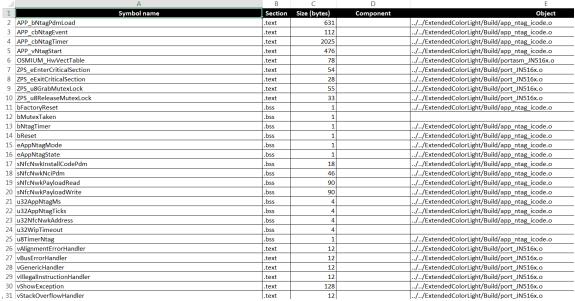
4	Α	В	С	D
1	Section name	Address	Size (bytes)	Region
2	.bir	0x00080000	16	flash
3	.flashheader	0x00080010	40	flash
4	.rodata	0x00080038	7660	flash
5	.text	0x00081E24	199468	flash
6	.data	0x0400004C	2324	ram
7	.bss	0x04000960	18772	ram
8	.heap	0x040052B4	2000	ram
9	.stack	0x04006C78	5000	ram

Example Sections page from JN-AN-1218 ExtendedColorLight

• **Components** – all components, including a catch-all entry for unresolved components, and their respective region sizes.

	A	В	C
1	Component name	flash (bytes)	ram (bytes)
2	Application	903	2340
3	Application (Common)	5338	2418
4	BDB	7683	790
5	Libraries	45804	1065
6	N/A	3722	267
7	NTAG	4705	287
8	PDUM	2894	4602
9	ZCIF	17583	1260
10	ZCL	30102	692
11	ZPS	77570	7100
12	ZigBee Common	1225	12
13	Totals	197529	20833

• **Symbols** – all symbols, their sections, sizes, components, the objects which they came from, and their respective library (if applicable).



Example Symbols page from JN-AN-1218 ExtendedColorLight

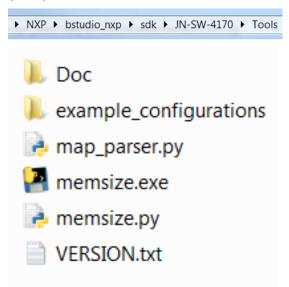
2 Capabilities

Product Type	Part Number	Build
JN516x ZLL/HA SDK	JN-SW-4168	1620
JN516x ZigBee 3.0 SDK	JN-SW-4170	1518
JN517x ZigBee 3.0 SDK	JN-SW-4270	1615
'BeyondStudio for NXP' Toolchain	JN-SW-4141	1308
LPCXpresso Toolchain	7.9.2	493

3 Integrating the tool

The memsize tool should be installed here:

(SDK)/Tools/Memsize2/



There are two changes that need to be made to the makefile in order to use the memsize tool. An example Makefile can be found in the folder 'example_configurations', for the JN-AN-1218 ExtendedColorLight. The alterations can be seen at lines 655 and 705. Please be aware that the examples used in this user guide are from the JN-AN-1218 ZigBee 3.0 Light Bulb v1003 app note.

First, a second linking should take place with LTO disabled (all one line);

```
$(CC) -WI,--cref -WI,--gc-sections -WI,-u_AppColdStart -WI,-u_AppWarmStart $(LDFLAGS) -T$(ZNCLKCMD) -L $(SDK_BASE_DIR)/Stack/ZCL/Build/ -o $@ -WI,--start-group $(APPOBJS) $(addprefix -I,$(LDLIBS)) -Im -WI,--end-group -fno-Ito -WI,- Map,$(DEV_BLD_DIR)/$(TARGET)_$(JENNIC_CHIP)$(BIN_SUFFIX)_NOLTO.map
```

This should take place immediately after the first linking. While the bold sections are specific to the second linking, non-bold sections from the line above may need to be adjusted to match the paths already used for the first linking, e.g. \$(APP_BLD_DIR) rather than \$(DEV_BLD_DIR).

Secondly, the memsize executable needs to be run (again, all one line);

```
$(SDK_BASE_DIR)/Tools/Memsize2/memsize.exe
$(DEV_BLD_DIR)/$(TARGET)_$(JENNIC_CHIP)$(BIN_SUFFIX).elf
$(DEV_BLD_DIR)/$(TARGET)_$(JENNIC_CHIP)$(BIN_SUFFIX)_NOLTO.map
$(TARGET).json
```

Please note that memsize is a post build process and should therefore be invoked last.

A relevant config (.json) file should have the same name as the binary file's target prefix, and should be added to the appropriate location in the app note, most likely 'Common'. The name is defined by the last parameter of the above line; (\$(TARGET).json).

For example, the configuration file for ExtendedColorLight can be found in "JN-AN-1218-ZigBee-3-0-Light-Bulb/Common_Light/Build/".

4 Configuration File

4.1 Description

The most complex part of the memsize tool is the sorting of symbols. They are split into user-defined logical categories called *Components*. Each component has two attributes: color (optional) and a list of patterns. The color is used for highlighting and the patterns are used to determine which symbol falls into the category. The way components are specified is via a config file, using the JSON format and it should conform to the following schema:

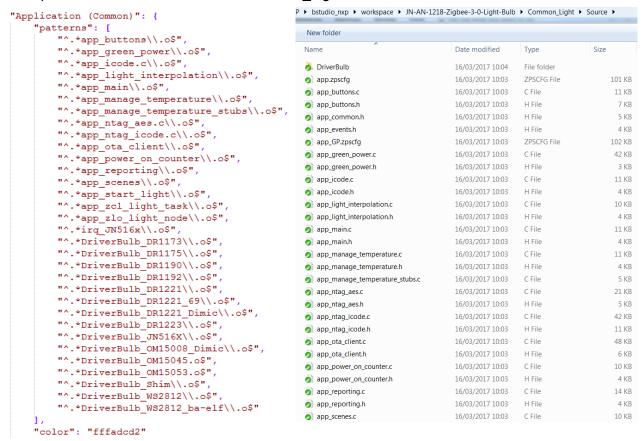
To see a collection of example files, please refer to the folder 'example configurations'.

4.2 Example: Extended Color Light

To begin, the application C files must be listed under 'Application'. Therefore, the Extended Color Light application lists;

ExtendedColorLight.json

All C files in the common folder must also be listed under 'Application (Common)'. In this example, the files are located in the 'Common_Light' folder;

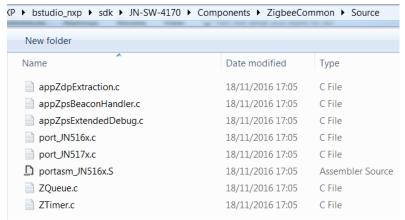


ExtendedColorLight.json

'Common_Light' Source folder

The NTAG files are also located in this directory, but are treated as their own object.

The rest of the objects (ZPS, PDUM, ZCL, ZCIF, BDB, ZigBee Common, ZigBee Utilities, Libraries) are found in the SDK, in a similar fashion to the Common files above;



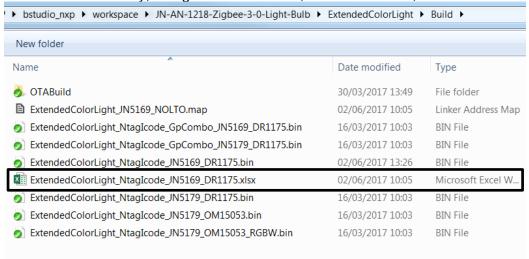
'ZigBeeCommon' Source files, 4170 SDK v1518

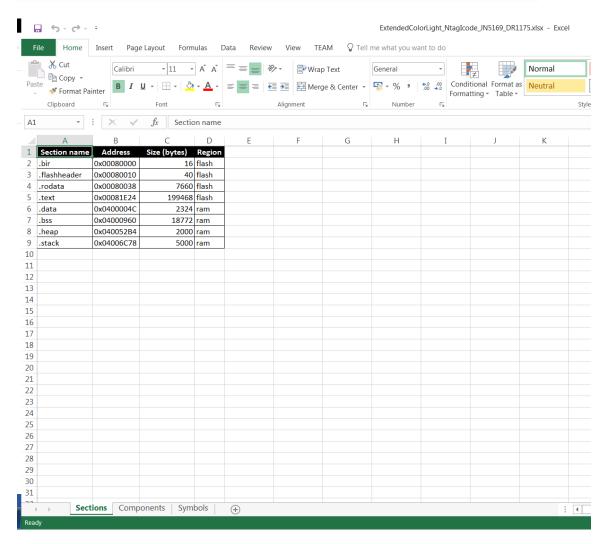
ExtendedColorLight.json

The required objects may differ between SDK and App Note application.

5 Running the demonstration

Before building, the .json configuration file must have been added to the 'Common' folder (or similar), and the makefile must be modified to include the second linking and Memsize tool invocation. Build the app note, and an ExcelWorkbook (.xlsx) will be created in the Build folder of that directory, along with the binaries, as shown below;





6 Creation of MemSize.exe

The process to create an executable file will be done with Pyinstaller. To know that the following process is applicable to all Python projects, only the section described as specific to MemSize application are mandatory for MemSize project.

6.1 Install Python 3.x

Ensure the latest Python 3.x version is installed in your computer: https://www.python.org/downloads/

6.2 Install pip

- 1. Download and store get-pip.py from the following link: https://bootstrap.pypa.io/get-pip.py
- 2. Double-click on your downloaded file if you have configured your PC to open .py files with Python

OR

From a command prompt windows (e.g. cmd), go the directory containing the Python source code you just downloaded and tape the following command: py -3 get-pip.py

- **3.** Go to Control Panel -> System -> Advanced system settings -> Environment Variables...
- **4.** In the System variables, search for **Path** variable and edit it to add the path to pip.exe: C:\Users\<your_user_name>\AppData\Local\Programs\Python\Python36-32\Scripts
- 5. Click OK to exit all windows

6.3 Install PyWin32

Select the right installer in the following link for your system and install PyWin32: https://github.com/mhammond/pywin32/releases

6.4 Install Pylnstaller

From a command prompt windows (e.g. cmd), simply tape the following command: pip install pyinstaller

6.5 Install jsonschema (specific to MemSize application)

From a command prompt windows (e.g. cmd), simply tape the following command: pip install jsonschema

6.6 Install openpyxl (specific to MemSize application)

From a command prompt windows (e.g. cmd), simply tape the following command: pip install openpyxl

6.7 Install jsonschema (specific to MemSize application)

From a command prompt windows (e.g. cmd), simply tape the following command: pip install pyelftools

6.8 Process to get the executable file from the Python source files

From a command prompt windows (e.g. cmd), go the directory containing the Python source code for MemSize and tape the following command:

pyinstaller --onefile memsize.py

(--onefile is used to package everything into a single executable. If you do not specify this option, the libraries, etc. will be distributed as separate files alongside the main executable)

The executable file will be created inside dist folder.

7 Release Details

7.1 New Features

ID	Feature	Description
Version 1002		
N/A	N/A	 Update source code to handle .ARM sections in the MAP file Update documentation to create the executable file of MemSize

7.2 Known Issues

ID	Severity	Description
Version 1002		
The tool lists that the data section is in RAM, but it is also in flash.		

7.3 Bug Fixes

ID	Description	
Version 1002		
artf543194	Memsize outputs map file warning	
[lpsw8737]		

Revision History

Version	Notes	
1000	First internal release	
1001	Initial release	
1002	 Update source code to handle .ARM sections in the MAP file Update documentation to create the executable file of MemSize 	

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